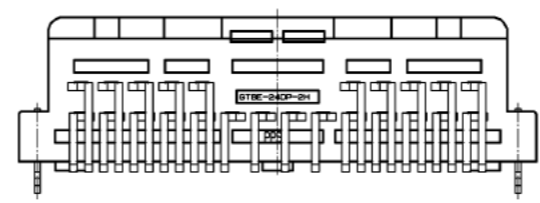
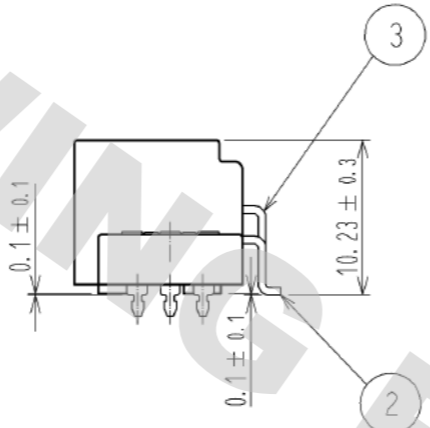
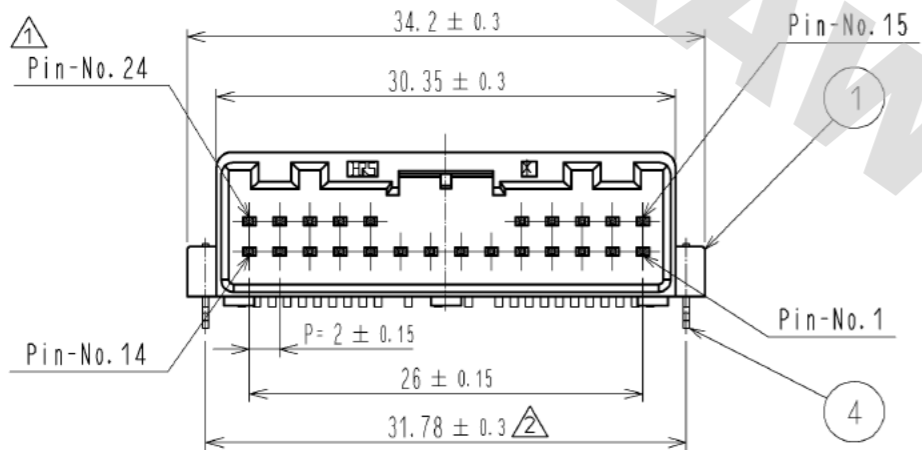
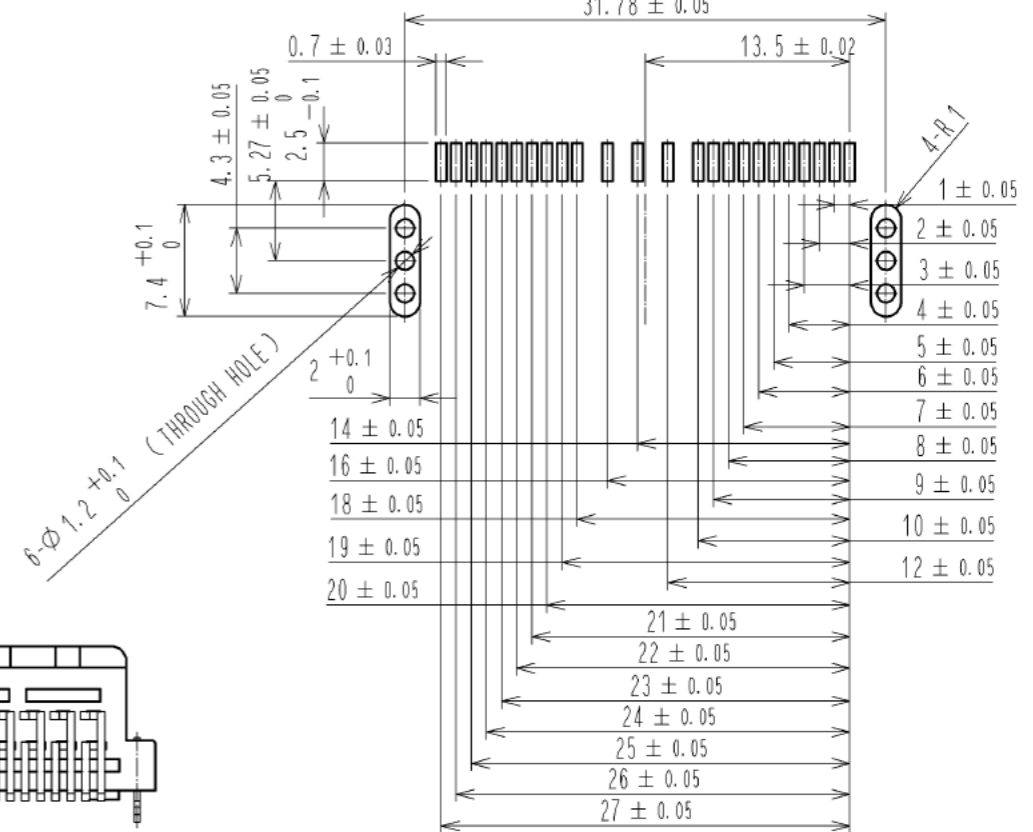
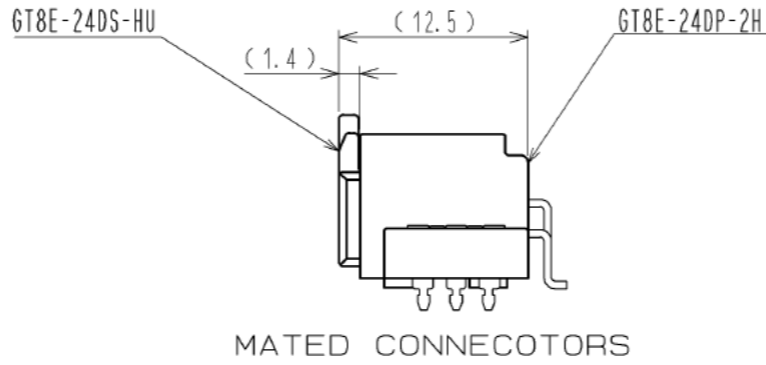
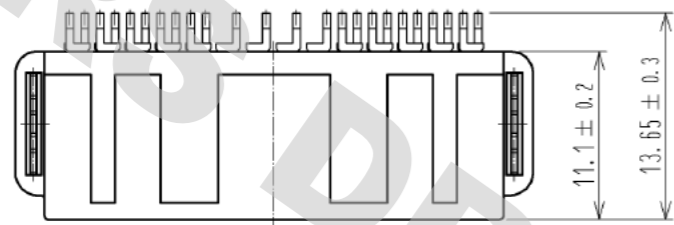
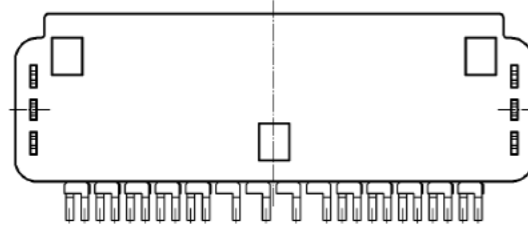


ELV, RoHS COMPLIANT

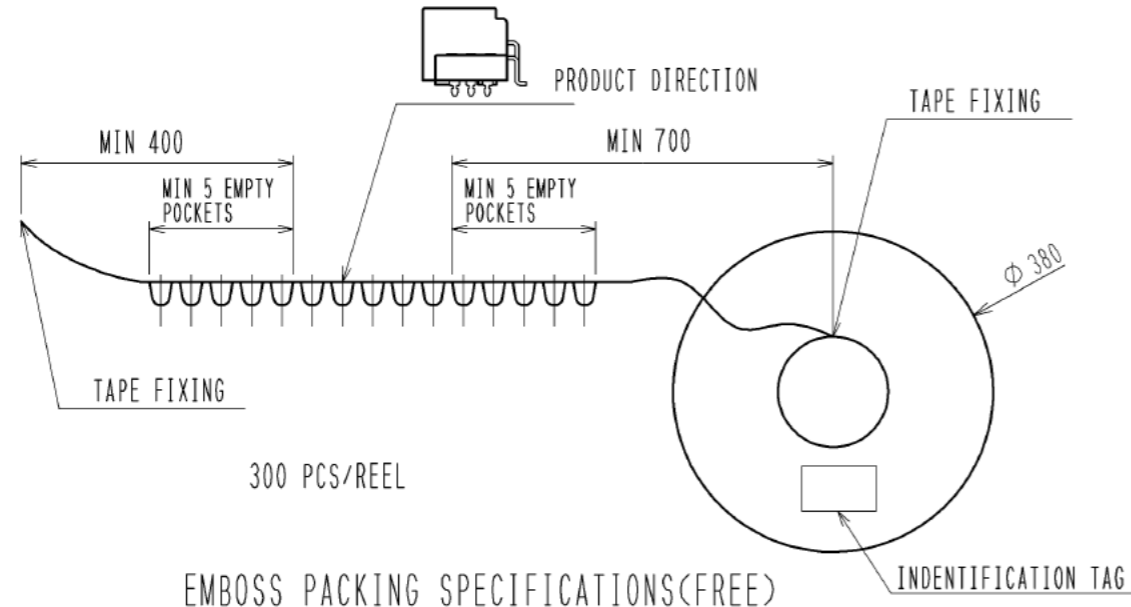
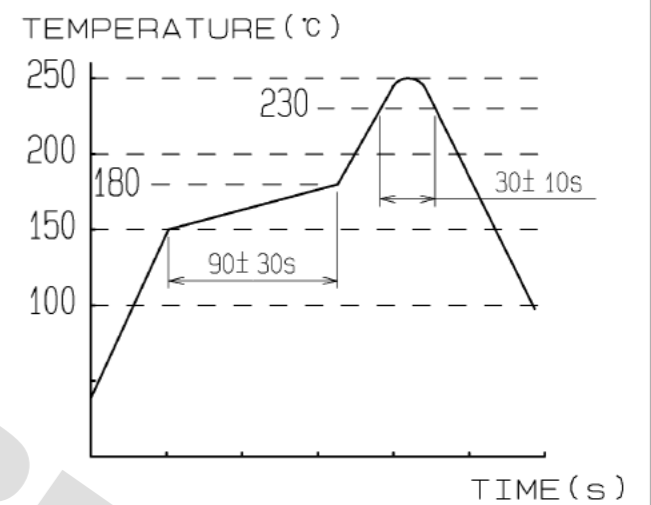
PIN-NO. 24 14 23 13 22 12 21 11 20 10 9 8 7 6 19 5 18 4 17 3 16 2 15 1



RECOMMENDED PC BOARD PATTERN (CONNECTOR SIDE)



- NOTE 1. RECOMMENDED REFLOW TEMPERATURE PROFILE (REFER RIGHT FIG.).
 REFLOW HEATING: FAR-INFLARED, IN THE AIR OR NITROGEN
 NUMBER OF REFLOW CYCLES: 2 CYCLES MAX
 PEAK TEMPERATURE: 250°C
 ABOVE 230°C: 20~40s
 PREHEAT: 150~180°C (60~120s)
 2. SOLDERING TEMPERATURE: 280~300°C (MAX 2s)
 3. COPLANARITY OF LEADS SHALL BE 0.1mm MAX.
 4. RECOMMENDED THICKNESS FOR PC BOARD IS 1.6mm.
 5. RECOMMENDED THICKNESS FOR SOLDER PASTE IS 0.15mm.



300 PCS/REEL

EMBOSS PACKING SPECIFICATIONS(FREE)

2	BRASS	TIN PLATING	4	BRASS	TIN PLATING
1	PPS	BLACK	3	BRASS	TIN PLATING
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
UNITS mm		SCALE 2 : 1	COUNT 1	DESCRIPTION OF REVISIONS DIS-T-003270	DESIGNED RZ. KANO
HRS HIROSE ELECTRIC CO., LTD.		APPROVED : AR. SHIRAI	12.09.14	DRAWING NO. EDC3-167887-00	CHECKED HS. OZAWA
		CHECKED : NH. NAKATA	12.09.14	PART NO. GT8E-24DP-2H	DATE 13.04.17
		DESIGNED : RZ. KANO	12.09.14	CODE NO. CL758-1011-7-00	
		DRAWN : RZ. KANO	12.09.14		

DRAWING FOR REFERENCE: This is subject to change without notice 05/31/2013

Mouser Electronics

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